# **MOSFET** – N-Channel, QFET<sup>®</sup>

1000 V, 8.0 A, 1.45  $\Omega$ 

# FQH8N100C

#### Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

#### Features

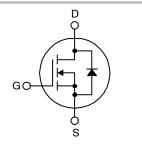
- 8 A, 1000 V,  $R_{DS(on)} = 1.45 \Omega$  (Max.) @  $V_{GS} = 10 V$
- Low Gate Charge (Typ. 53 nC)
- Low Crss (Typ. 16 pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- This Device is Pb-Free and is RoHS Compliant



# **ON Semiconductor®**

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V <sub>DS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX	
1000 V	1.45 Ω @ 10 V	8 A	

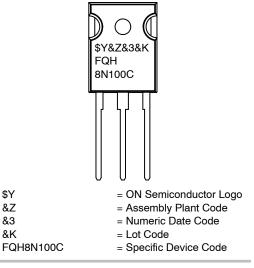


N-CHANNEL MOSFET



TO-247-3LD CASE 340CK

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	FQH8N100C	Unit V	
V <sub>DSS</sub>	Drain-Source Voltage			1000
ID	Drain Current:	Continuous (T <sub>C</sub> = 25°C)	8.0	А
		Continuous (T <sub>C</sub> = 100°C)	5.0	
I <sub>DM</sub>	Drain Current:	Pulsed (Note 1)	32	A
V <sub>GSS</sub>	Gate-Source Voltage		±30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		850	mJ
I <sub>AR</sub>	Avalanche Current (Note 1)		8.0	A
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		22	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.0	V/ns
P <sub>D</sub>	Power Dissipation	$T_{\rm C} = 25^{\circ}{\rm C}$	225	W
		Derate Above 25°C	1.79	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		–55 to + 150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: Pulse-width limited by maximum junction temperature. 2. L = 25 mH, I<sub>AS</sub> = 8.0 A, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25  $\Omega$ , Starting T<sub>J</sub> = 25°C 3. I<sub>SD</sub> ≤ 8.0 A, di/dt ≤ 200 A/µs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C.

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
FQH8N100C	FQH8N100C	TO-247	Tube	N/A	N/A	30 Units

#### THERMAL CHARACTERISTICS

Symbol	Parameter	FQH8N100C	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.56	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

#### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS	-				
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A	1000	-	-	V
$\Delta BV_{DSS}$ $/\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C	-	1.4	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS}$ = 1000 V, $V_{GS}$ = 0 V	-	-	10	μΑ
		$V_{DS}$ = 800 V, $T_{C}$ = 125 °C	-	-	100	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	$V_{GS}$ = 30 V, $V_{DS}$ = 0 V	-	-	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS} = -30$ V, $V_{DS} = 0$ V	-	-	-100	nA
ON CHARA	CTERISTICS					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \ \mu A$	3.0	-	5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 4.0 \text{ A}$	-	1.2	1.45	Ω
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 4.0 \text{ A}$	-	8.0	-	S
OYNAMIC C	HARACTERISTICS					
C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 25 V, $V_{GS}$ = 0 V, f = 1.0 MHz	-	2475	3220	pF
C <sub>oss</sub>	Output Capacitance		-	195	255	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	16	21	pF
WITCHING	CHARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 500 \text{ V}, \text{ I}_{D} = 8.0 \text{ A},$	-	50	110	ns
t <sub>r</sub>	Turn-On Rise Time	R <sub>G</sub> = 25 Ω (Note 4)	-	95	200	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	122	254	ns
t <sub>f</sub>	Turn-Off Fall Time		-	80	170	ns
Qg	Total Gate Charge	$V_{DS} = 800 \text{ V}, \text{ I}_{D} = 8.0 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$ (Note 4)	-	53	70	nC
Q <sub>gs</sub>	Gate-Source Charge		-	13	-	nC
Q <sub>gd</sub>	Gate-Drain Charge		-	23	-	nC
DRAIN-SOU	IRCE DIODE CHARACTERISTICS AND M	AXIMUM RATINGS				
IS	Maximum Continuous Source-Drain Diode Forward Current			-	8.0	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current		-	-	32.0	Α
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 8.0 \text{ A}$	-	-	1.4	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 8.0 A,$	-	620	-	ns
Qrr	Reverse Recovery Charge	dl <sub>F</sub> /dt = 100 A/μs	_	5.2	_	uC

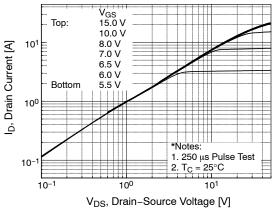
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature.

μC

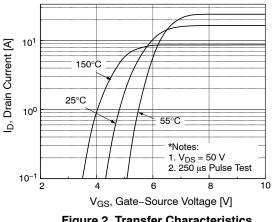
Reverse Recovery Charge

Q<sub>rr</sub>

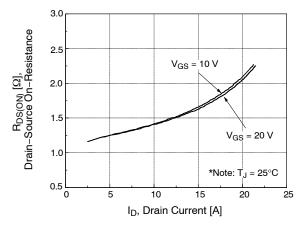
## **TYPICAL PERFORMANCE CHARACTERISTICS**



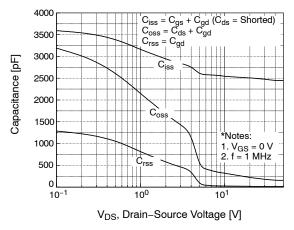




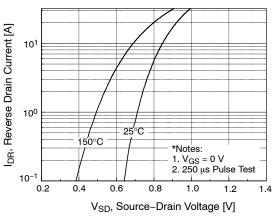


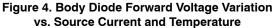






**Figure 5. Capacitance Characteristics** 





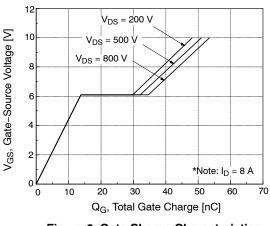


Figure 6. Gate Charge Characteristics

### TYPICAL PERFORMANCE CHARACTERISTICS (continued)

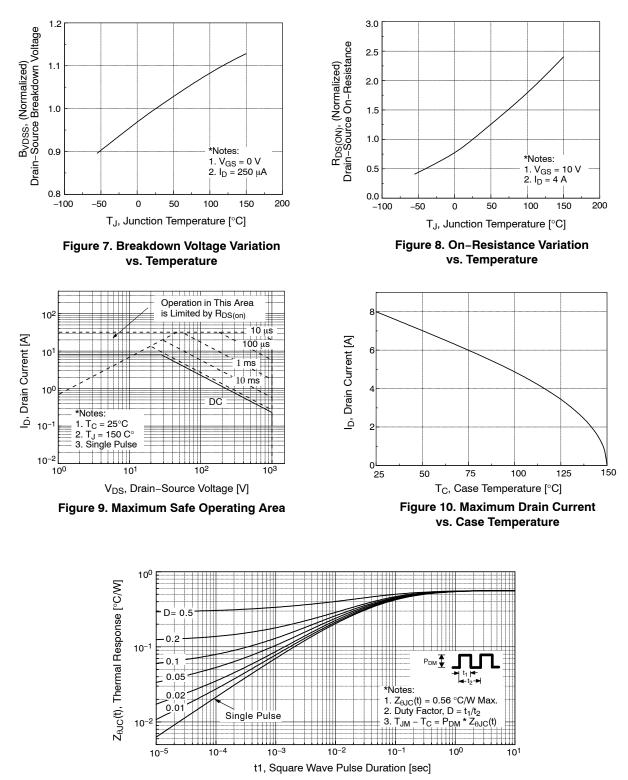
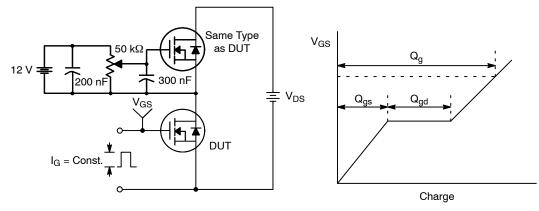


Figure 11. Transient Thermal Response Curve





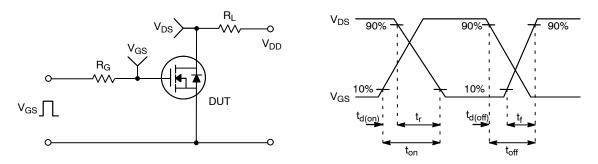
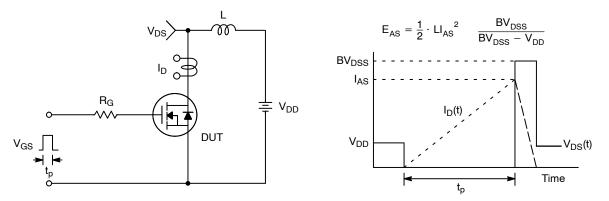


Figure 13. Resistive Switching Test Circuit & Waveforms





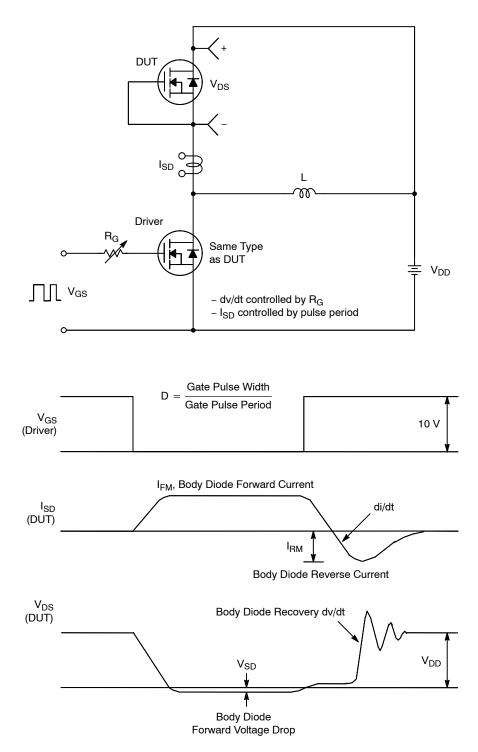


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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